Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.						This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1	-21.1 IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x				ard Form Type * Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information							
Supplier	Information														
Company	name*	Company unique ID				Unique ID Authority					Response Date*				
onsemi												2024-05-15			
Contact Na	ame	Title - Contact				Phone - Contact*					Email - Contact*				
Product-E	Env-Stewards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
Authorized	d Representative*	Title - Representative				Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
	Requester Item Number	uester Item Number Mfr Item		Number Mfr Item Name			Effective	Date	Version	Manu	Manufacturing Site		Weight*	UOM	Unit Type
	CAT809			TBI-GT3 SUP, PUSH-PULL, ACT LOW			2024-05-	15		THB	ТНВ		14.1	mg	Each
Manufacturing Process Information															
	Terminal Plating / Grid Array Material T			Terminal Base Alloy J-STD-020 MS			Peak Process Body Temperature Max Time at Pea			k Temperature Number of Reflow Cycles					
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1			260	<b>260</b> C		3	30 seco		seconds 3			
Comments															
level 1 - maximum time at peak temperature during soldering is 10-30 seconds															
For more information regarding material composition please refer to page 3															

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.15	0.15 mg Supplier Silicon (Si)		Silicon (Si)	7440-21-3		0.15	mg
Die Attach	1.0E-4	mg		Epoxy resin	proprietary data		0	mg
			Supplier	Fatty acids, C18-unsatd., dimers, polymers with epichlorhydrin	68475-94-5		0	mg
			Supplier	2,2'-[[2-(oxiranylmethoxy)-1,3-phenylene]bis(methylene)]bisoxirane	13561-08-5		0	mg
			Supplier	4-Methyl-2-Phenyl-1H-Imidazole	827-43-0		0	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0	mg
Lead Frame	0.7943	mg	Supplier	Zinc (Zn)	7440-66-6		0.001	mg
			Supplier	Iron (Fe)	7439-89-6		0.0187	mg
			Supplier	Copper (Cu)	7440-50-8		0.7744	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0002	mg
Mold Compound-Black	13.11	mg		Epoxy resin	proprietary data		0.6555	mg
			Supplier	Phenolic Resin	Proprietary Data		0.2622	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.3277	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0655	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.799	mg
Plating	0.008	mg	Supplier	Palladium (Pd)	7440-05-3		0.0003	mg
			В	Nickel (Ni)	7440-02-0		0.0076	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
Wire Bond - Au	0.0376	mg	Supplier	Gold (Au)	7440-57-5		0.0376	mg